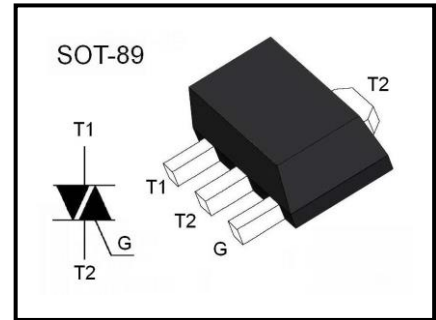


General Description

Glass passivated triacs in a plastic envelope suitable for surface mounting, intended for use in applications requiring high bidirectional transient and blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.



Absolute Maximum Rating (Ta=25°C)

Limiting values in accordance with the Absolute Maximum System

Parameter	Symbol	Conditions	Min	Max	Unit	
Repetitive peak off-state voltages	V_{DRM}		-	600	V	
On-State RMS Current	$I_{T(RMS)}$	full sine wave; $T_{mb} \leq 108\text{ }^{\circ}\text{C}$	-	1	A	
Non-repetitive peak on-state current	I_{TSM}	full sine wave; $T_j = 25\text{ }^{\circ}\text{C}$ prior to surge	$t = 20\text{ ms}$	-	10	A
			$t = 16.7\text{ ms}$	-	11	
I^2t for fusing	I^2t	$t = 10\text{ ms}$	-	0.5	A^2s	
Repetitive rate of rise of on-state current after triggering	di_T/dt	$I_{TM} = 1.5\text{ A}; I_G = 0.2\text{ A}; di_G/dt = 0.2\text{ A}/\mu\text{s}$	T2+ G+	-	50	A/ μs
			T2+ G-	-	50	
			T2- G-	-	50	
			T2- G+	-	10	
Peak gate current	I_{GM}		-	2	A	
Peak Gate Voltage	V_{GM}		-	5	V	
Peak gate power	P_{GM}		-	5	W	
Average gate power	$P_{G(AV)}$	over any 20 ms period	-	0.5	W	
Operating junction temperature	T_j		-	125	$^{\circ}\text{C}$	
Storage Temperature	T_{stg}		-40	150	$^{\circ}\text{C}$	

Thermal Resistances

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Thermal resistance junction to solder point	R_{thj-sp}	full or half cycle	-		15	K/W
Thermal resistance junction to ambient	R_{thj-a}	pcb mounted; minimum footprint	-	156		K/W
		pcb mounted;		70		

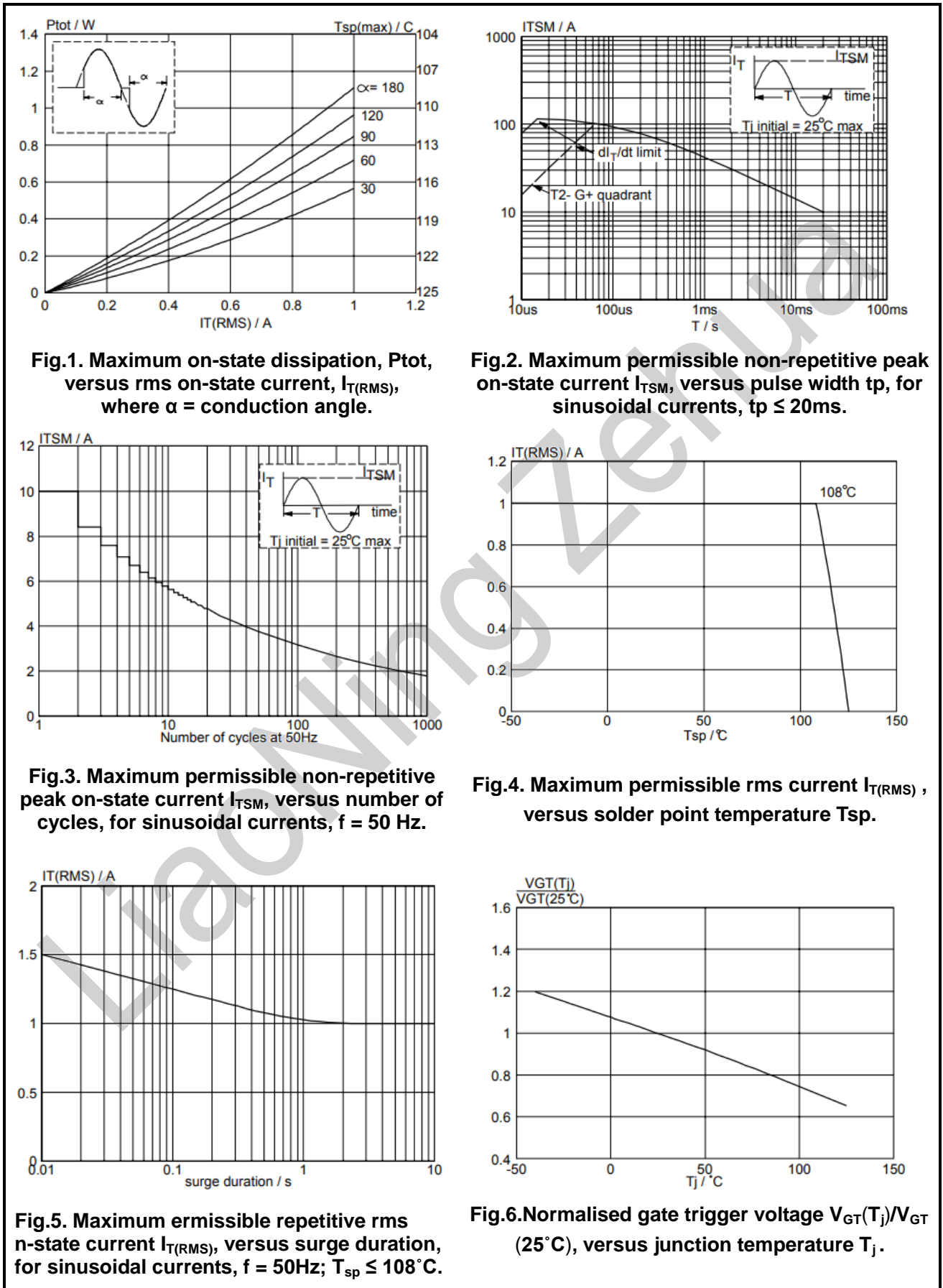
Static Characteristics $T_j = 25\text{ }^\circ\text{C}$ unless otherwise stated

Parameter	Symbol	Conditions	Min	Typ	Max	Unit	
Gate trigger current	I_{GT}	$V_D = 12\text{ V}$ $I_T = 0.1\text{ A}$	T2+ G+	-		10	mA
			T2+ G-	-		10	
			T2- G-	-		10	
			T2- G+	-		15	
Latching current	I_L	$V_D = 12\text{ V}$ $I_{GT} = 0.1\text{ A}$	T2+ G+	-		10	mA
			T2+ G-	-		15	
			T2- G-	-		10	
			T2- G+	-		15	
Holding current	I_H	$V_D = 12\text{ V}$, $I_{GT} = 0.1\text{ A}$			30	mA	
On-state voltage	V_T	$I_T = 1.5\text{ A}$			2.2	V	
Gate trigger voltage	V_{GT}	$V_D = 12\text{ V}$; $I_T = 0.1\text{ A}$ $V_D = 400\text{ V}$; $I_T = 0.1\text{ A}$; $T_j = 125\text{ }^\circ\text{C}$	0.25		1.5	V	
Off-state leakage current	I_D	$V_D = V_{DRM(max)}$; $T_j = 125\text{ }^\circ\text{C}$			0.5	mA	

Dynamic Characteristics $T_j = 25\text{ }^\circ\text{C}$ unless otherwise stated

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Critical rate of rise of rate of rise of	dV_D/dt	$V_{DM} = 67\% V_{DRM(max)}$; $V_{DM} = 67\% V_{DRM(max)}$; $V_{DM} = 67\% V_{DRM(max)}$; circuit	50	250	-	V/ μs
Critical rate of change of commutating voltage	dV_{com}/dt	$V_{DM} = 400\text{ V}$; $T_j = 95\text{ }^\circ\text{C}$; $I_{T(RMS)} = 1\text{ A}$; $dI_{com}/dt = 1.8\text{ A/ms}$; gate open circuit	10	50	-	V/ μs
Gate controlled turn-on time	tgt	$I_{TM} = 1.5\text{ A}$; $V_D = V_{DRM(max)}$; $I_G = 0.1\text{ A}$; $dI_G/dt = 5\text{ A}/\mu\text{s}$;				μs

Typical Characteristics



Typical Characteristics

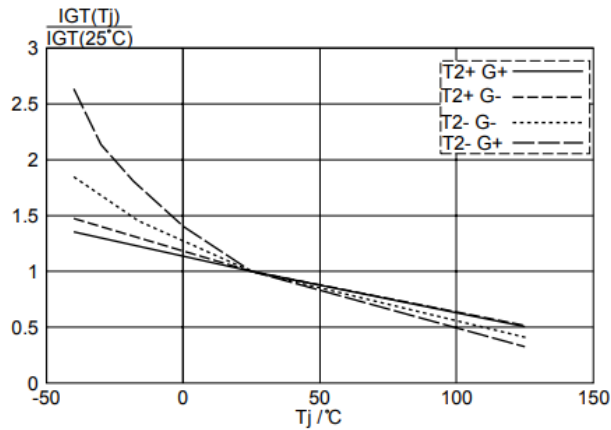


Fig.7. Normalised gate trigger current $I_{GT}(T_j) / I_{GT}(25^\circ\text{C})$, versus junction temperature T_j .

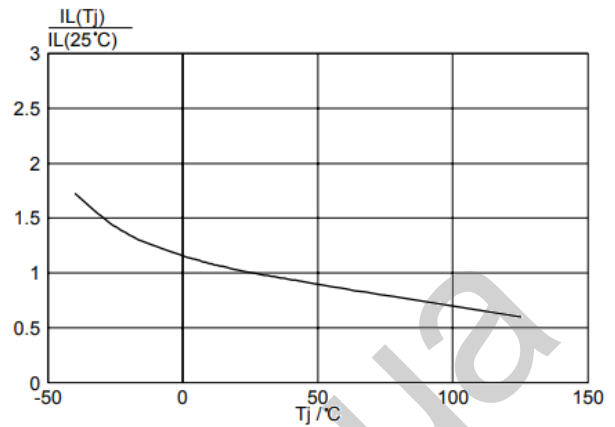


Fig.8. Normalised latching current $I_L(T_j) / I_L(25^\circ\text{C})$, versus junction temperature T_j .

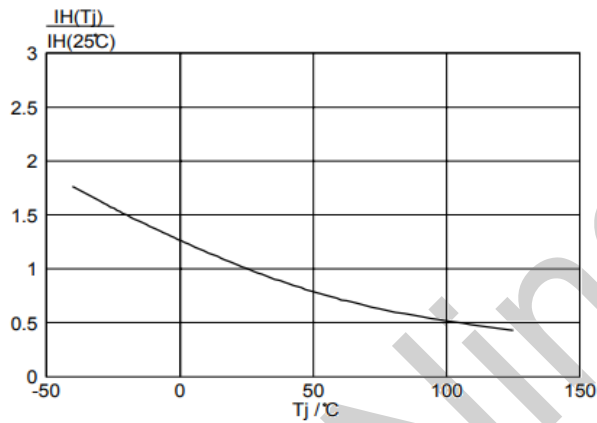


Fig.9. Normalised holding current $I_H(T_j) / I_H(25^\circ\text{C})$, versus junction temperature T_j .

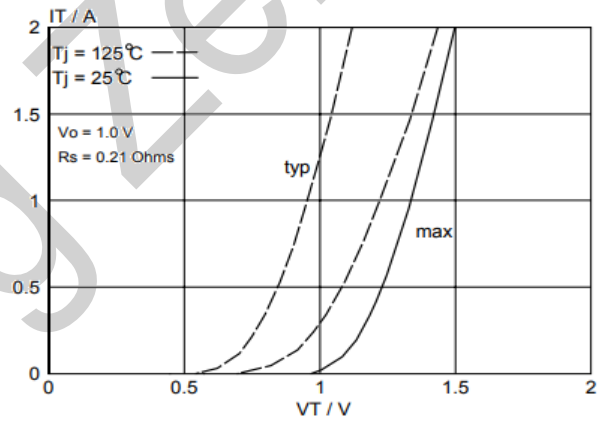


Fig.10. Typical and maximum on-state characteristic.

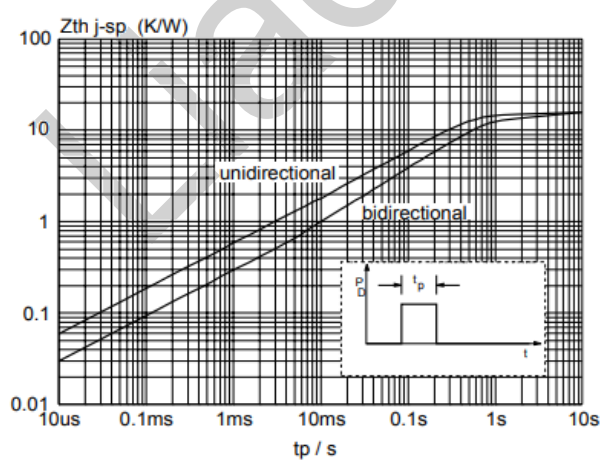


Fig.11. Transient thermal impedance $Z_{th\ j-sp}$, versus pulse width t_p .

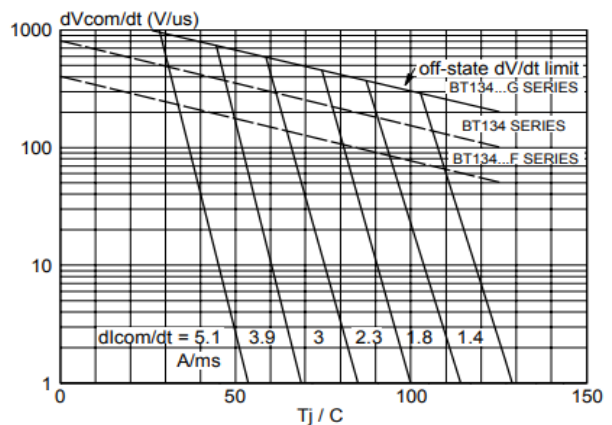
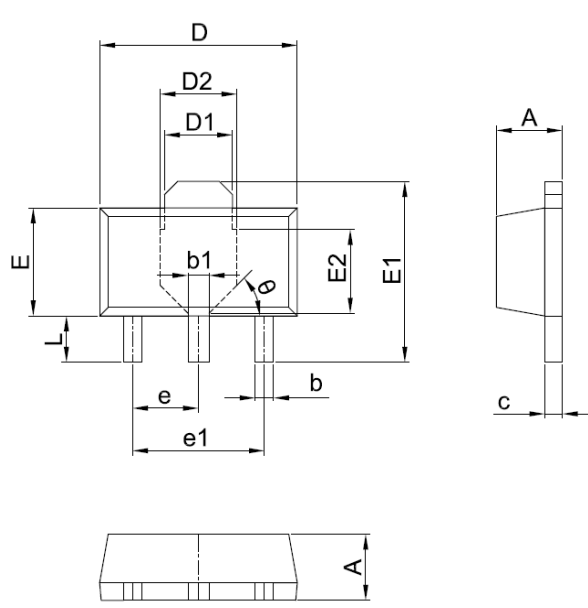


Fig.12. Typical commutation dV/dt versus junction temperature, parameter commutation dI_T/dt . The triac should commute when the dV/dt is below the value on the appropriate curve for pre-commutation dI_T/dt .

Package Dimensions



Dim	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	1.40	1.60	0.055	0.063
b	0.32	0.52	0.013	0.020
b1	0.38	0.58	0.015	0.023
c	0.35	0.45	0.014	0.018
D	4.40	4.60	0.173	0.181
D1	1.45	1.65	0.057	0.065
D2	1.70	1.80	0.067	0.071
E	2.30	2.60	0.091	0.102
E1	3.95	4.25	0.156	0.167
E2	1.80	2.00	0.071	0.079
e	1.40	1.60	0.055	0.063
e1	2.80	3.20	0.110	0.126
L	0.90	1.20	0.035	0.047